

HA-2420, HA-2425

Absolute Maximum Ratings

| | |
|---|-------------------------|
| Voltage Between V+ and V- Terminals | .40V |
| Differential Input Voltage | .24V |
| Digital Input Voltage (Sample and Hold Pin) | +8V, -15V |
| Output Current | Short Circuit Protected |

Operating Conditions

| | |
|--------------------------------|----------------|
| Temperature Range | |
| HA-2420-2 | -55°C to 125°C |
| HA-2425-5 | 0°C to 75°C |
| Supply Voltage Range (Typical) | ±12V to ±15V |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. θ_{JA} is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

Thermal Information

| | | |
|---|----------------------|----------------------|
| Thermal Resistance (Typical, Note 1) | θ_{JA} (°C/W) | θ_{JC} (°C/W) |
| CERDIP Package | 75 | 20 |
| PDIP Package | 95 | N/A |
| Maximum Junction Temperature (Ceramic Packages) | 175°C | |
| Maximum Junction Temperature (Plastic Package) | 150°C | |
| Maximum Storage Temperature Range | -65°C to 150°C | |
| Maximum Lead Temperature (Soldering 10s) | 300°C | |

Electrical Specifications

Test Conditions (Unless Otherwise Specified) $V_{SUPPLY} = \pm 15.0V$; $C_H = 1000pF$; Digital Input: $V_{IL} = +0.8V$ (Sample), $V_{IH} = +2.0V$ (Hold), Unity Gain Configuration (Output tied to Negative Input)

| PARAMETER | TEST CONDITIONS | TEMP. (°C) | HA-2420-2 | | | HA-2425-5 | | | UNITS |
|--|--------------------------------------|------------|-----------|------|-----|-----------|------|-----|-------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| INPUT CHARACTERISTICS | | | | | | | | | |
| Input Voltage Range | | Full | ±10 | - | - | ±10 | - | - | V |
| Offset Voltage | | 25 | - | 2 | 4 | - | 3 | 6 | mV |
| | | Full | - | 3 | 6 | - | 4 | 8 | mV |
| Bias Current | | 25 | - | 40 | 200 | - | 40 | 200 | nA |
| | | Full | - | - | 400 | - | - | 400 | nA |
| Offset Current | | 25 | - | 10 | 50 | - | 10 | 50 | nA |
| | | Full | - | - | 100 | - | - | 100 | nA |
| Input Resistance | | 25 | 5 | 10 | - | 5 | 10 | - | MΩ |
| Common Mode Range | | Full | ±10 | - | - | ±10 | - | - | V |
| TRANSFER CHARACTERISTICS | | | | | | | | | |
| Large Signal Voltage Gain | $R_L = 2k\Omega$, $V_O = 20V_{P-P}$ | Full | 25 | 50 | - | 25 | 50 | - | kV/V |
| Common Mode Rejection | $V_{CM} = \pm 10V$ | Full | 80 | 90 | - | 74 | 90 | - | dB |
| Hold Mode Feedthrough Attenuation (Note 2) | $f_{IN} \leq 100kHz$ | Full | - | -76 | - | - | -76 | - | dB |
| Gain Bandwidth Product (Note 2) | | 25 | - | 2.5 | - | - | 2.5 | - | MHz |
| OUTPUT CHARACTERISTICS | | | | | | | | | |
| Output Voltage Swing | $R_L = 2k\Omega$ | Full | ±10 | - | - | ±10 | - | - | V |
| Output Current | | 25 | ±15 | - | - | ±15 | - | - | mA |
| Full Power Bandwidth (Note 2) | $V_O = 20V_{P-P}$ | 25 | - | 100 | - | - | 100 | - | kHz |
| Output Resistance | DC | 25 | - | 0.15 | - | - | 0.15 | - | Ω |
| TRANSIENT RESPONSE | | | | | | | | | |
| Rise Time (Note 2) | $V_O = 200mV_{P-P}$ | 25 | - | 75 | 100 | - | 75 | 100 | ns |
| Overshoot (Note 2) | $V_O = 200mV_{P-P}$ | 25 | - | 25 | 40 | - | 25 | 40 | % |
| Slew Rate (Note 2) | $V_O = 10V_{P-P}$ | 25 | 3.5 | 5 | - | 3.5 | 5 | - | V/μs |

HA-2420, HA-2425

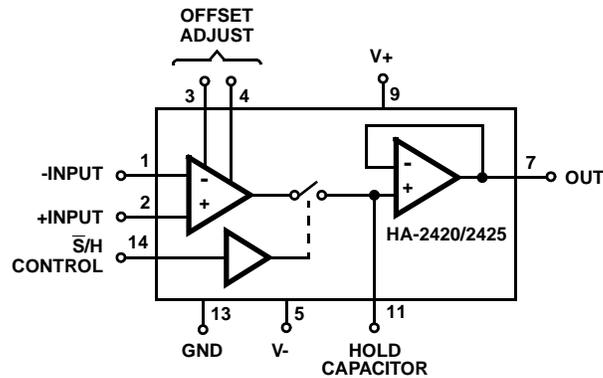
Electrical Specifications Test Conditions (Unless Otherwise Specified) $V_{SUPPLY} = \pm 15.0V$; $C_H = 1000pF$; Digital Input: $V_{IL} = +0.8V$ (Sample), $V_{IH} = +2.0V$ (Hold), Unity Gain Configuration (Output tied to Negative Input) **(Continued)**

| PARAMETER | TEST CONDITIONS | TEMP. (°C) | HA-2420-2 | | | HA-2425-5 | | | UNITS |
|--|-------------------|------------|-----------|-----|------|-----------|-----|------|---------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| DIGITAL INPUT CHARACTERISTICS | | | | | | | | | |
| Digital Input Current | $V_{IN} = 0V$ | Full | - | - | -0.8 | - | - | -0.8 | mA |
| | $V_{IN} = 5V$ | Full | - | - | 20 | - | - | 20 | μA |
| Digital Input Voltage | Low | Full | - | - | 0.8 | - | - | 0.8 | V |
| | High | Full | 2.0 | - | - | 2.0 | - | - | V |
| SAMPLE AND HOLD CHARACTERISTICS | | | | | | | | | |
| Acquisition Time (Note 2) | To 0.1% 10V Step | 25 | - | 2.3 | 4 | - | 2.3 | 4 | μs |
| Acquisition Time (Note 2) | To 0.01% 10V Step | 25 | - | 3.2 | 6 | - | 3.2 | 6 | μs |
| Hold Step Error | $V_{IN} = 0V$ | 25 | - | 10 | 20 | - | 10 | 20 | mV |
| Hold Mode Settling Time | To $\pm 1mV$ | 25 | - | 860 | - | - | 860 | - | ns |
| Aperture Time (Note 3) | | 25 | - | 30 | - | - | 30 | - | ns |
| Effective Aperture Delay Time | | 25 | - | 30 | - | - | 30 | - | ns |
| Aperture Uncertainty | | 25 | - | 5 | - | - | 5 | - | ns |
| Drift Current (Note 2) | $V_{IN} = 0V$ | 25 | - | 5 | - | - | 5 | - | μA |
| HA1-2420 | | Full | - | 1.8 | 10 | - | - | - | nA |
| HA1-2425 | | Full | - | - | - | - | 0.1 | 1.0 | nA |
| HA3-2425, HA4P2425, HA9P2425 | | Full | - | - | - | - | 7.5 | 10.0 | nA |
| POWER SUPPLY CHARACTERISTICS | | | | | | | | | |
| Supply Current (+) | | 25 | - | 3.5 | 5.5 | - | 3.5 | 5.5 | mA |
| Supply Current (-) | | 25 | - | 2.5 | 3.5 | - | 2.5 | 3.5 | mA |
| Power Supply Rejection | | Full | 80 | 90 | - | 74 | 90 | - | dB |

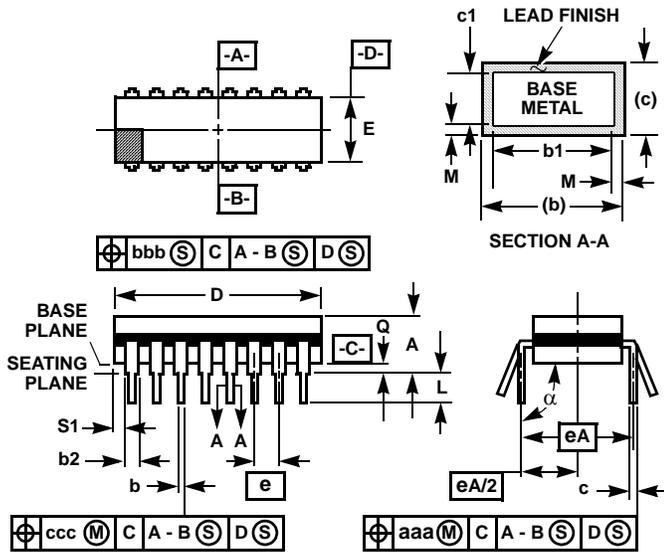
NOTES:

2. $A_V = \pm 1$, $R_L = 2k\Omega$, $C_L = 50pF$.
3. Derived from computer simulation only; not tested.

Functional Diagram



Ceramic Dual-In-Line Frit Seal Packages (CERDIP)



**F14.3 MIL-STD-1835 GDIP1-T14 (D-1, CONFIGURATION A)
14 LEAD CERAMIC DUAL-IN-LINE FRIT SEAL PACKAGE**

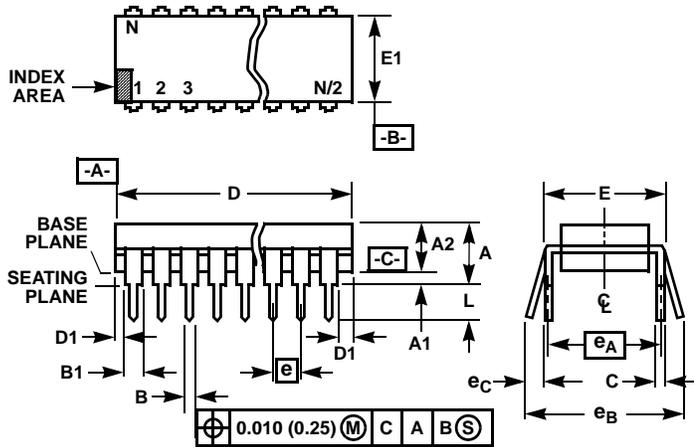
| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|----------|-----------|--------|-------------|-------|-------|
| | MIN | MAX | MIN | MAX | |
| A | - | 0.200 | - | 5.08 | - |
| b | 0.014 | 0.026 | 0.36 | 0.66 | 2 |
| b1 | 0.014 | 0.023 | 0.36 | 0.58 | 3 |
| b2 | 0.045 | 0.065 | 1.14 | 1.65 | - |
| b3 | 0.023 | 0.045 | 0.58 | 1.14 | 4 |
| c | 0.008 | 0.018 | 0.20 | 0.46 | 2 |
| c1 | 0.008 | 0.015 | 0.20 | 0.38 | 3 |
| D | - | 0.785 | - | 19.94 | 5 |
| E | 0.220 | 0.310 | 5.59 | 7.87 | 5 |
| e | 0.100 BSC | | 2.54 BSC | | - |
| eA | 0.300 BSC | | 7.62 BSC | | - |
| eA/2 | 0.150 BSC | | 3.81 BSC | | - |
| L | 0.125 | 0.200 | 3.18 | 5.08 | - |
| Q | 0.015 | 0.060 | 0.38 | 1.52 | 6 |
| S1 | 0.005 | - | 0.13 | - | 7 |
| α | 90° | 105° | 90° | 105° | - |
| aaa | - | 0.015 | - | 0.38 | - |
| bbb | - | 0.030 | - | 0.76 | - |
| ccc | - | 0.010 | - | 0.25 | - |
| M | - | 0.0015 | - | 0.038 | 2, 3 |
| N | 14 | | 14 | | 8 |

NOTES:

1. Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
2. The maximum limits of lead dimensions b and c or M shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
3. Dimensions b1 and c1 apply to lead base metal only. Dimension M applies to lead plating and finish thickness.
4. Corner leads (1, N, N/2, and N/2+1) may be configured with a partial lead paddle. For this configuration dimension b3 replaces dimension b2.
5. This dimension allows for off-center lid, meniscus, and glass overrun.
6. Dimension Q shall be measured from the seating plane to the base plane.
7. Measure dimension S1 at all four corners.
8. N is the maximum number of terminal positions.
9. Dimensioning and tolerancing per ANSI Y14.5M - 1982.
10. Controlling dimension: INCH.

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Dual-In-Line Plastic Packages (PDIP)



NOTES:

1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
6. E and e_A are measured with the leads constrained to be perpendicular to datum $-C-$.
7. e_B and e_C are measured at the lead tips with the leads unconstrained. e_C must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

E14.3 (JEDEC MS-001-AA ISSUE D)
14 LEAD DUAL-IN-LINE PLASTIC PACKAGE

| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|--------|-----------|-------|-------------|-------|-------|
| | MIN | MAX | MIN | MAX | |
| A | - | 0.210 | - | 5.33 | 4 |
| A1 | 0.015 | - | 0.39 | - | 4 |
| A2 | 0.115 | 0.195 | 2.93 | 4.95 | - |
| B | 0.014 | 0.022 | 0.356 | 0.558 | - |
| B1 | 0.045 | 0.070 | 1.15 | 1.77 | 8 |
| C | 0.008 | 0.014 | 0.204 | 0.355 | - |
| D | 0.735 | 0.775 | 18.66 | 19.68 | 5 |
| D1 | 0.005 | - | 0.13 | - | 5 |
| E | 0.300 | 0.325 | 7.62 | 8.25 | 6 |
| E1 | 0.240 | 0.280 | 6.10 | 7.11 | 5 |
| e | 0.100 BSC | | 2.54 BSC | | - |
| e_A | 0.300 BSC | | 7.62 BSC | | 6 |
| e_B | - | 0.430 | - | 10.92 | 7 |
| L | 0.115 | 0.150 | 2.93 | 3.81 | 4 |
| N | 14 | | 14 | | 9 |

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